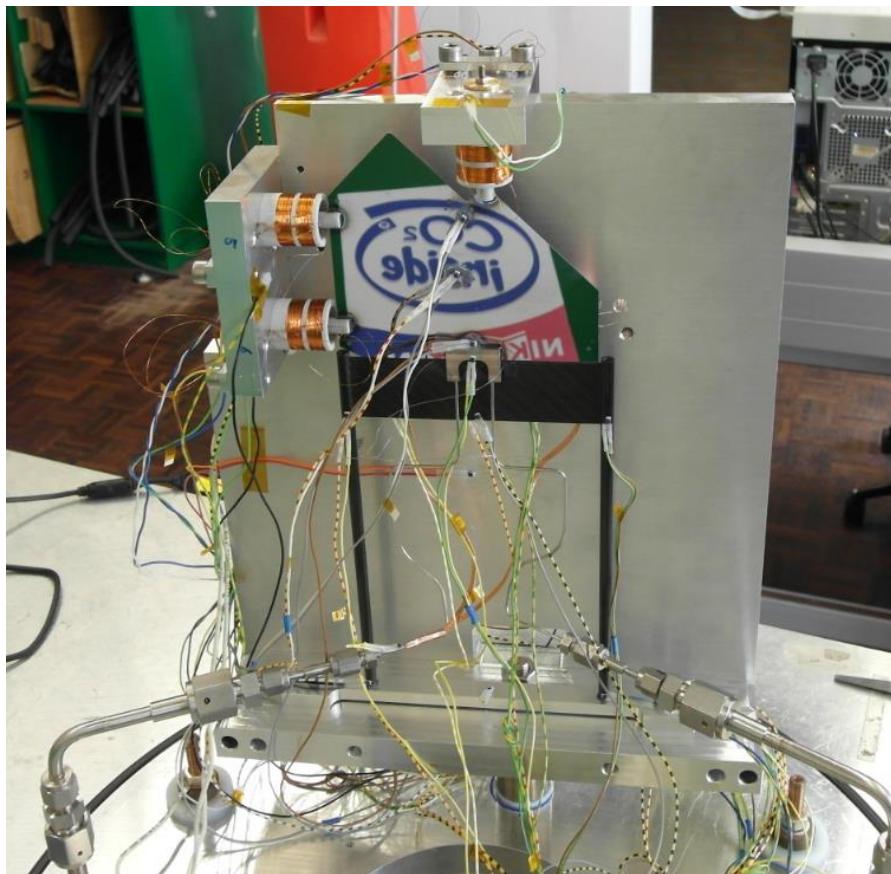


Nikhef VELO module measurement results



Contents

- Test setup
- Displacement results
 - Module I
 - Module II
 - Module III
- Thermal model
- Creep test results
- Conclusion

Test setup

- 6 LVDT sensors
- 16 temperature sensors PT100
- Temperature control for frame
- Vacuum pressure better than 10^{-4} mbar

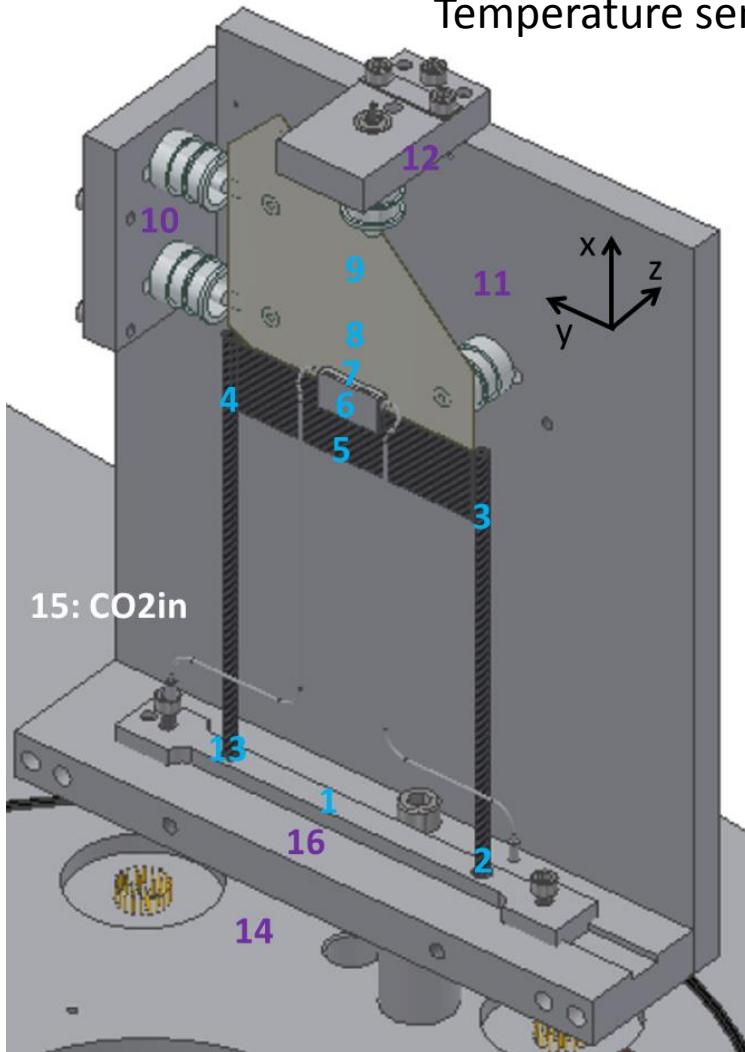
More info:

<https://indico.cern.ch/event/364489/contribution/1/material/slides/1.pdf>

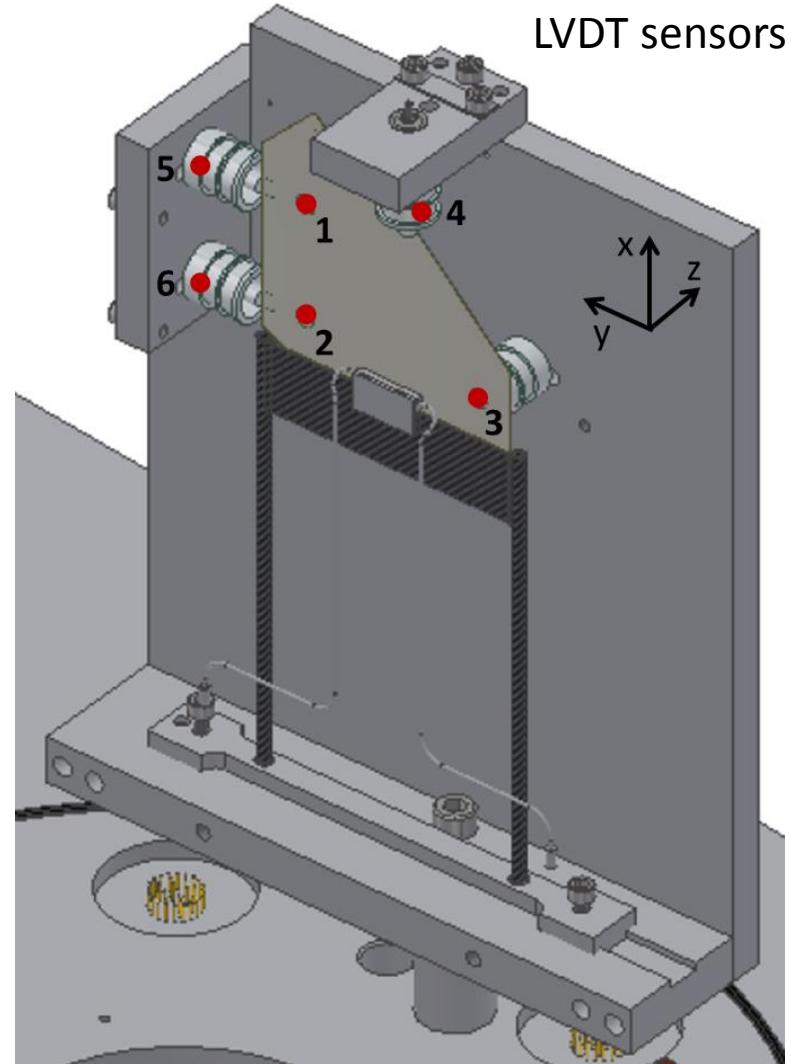


Location sensors

Temperature sensors



LVDT sensors

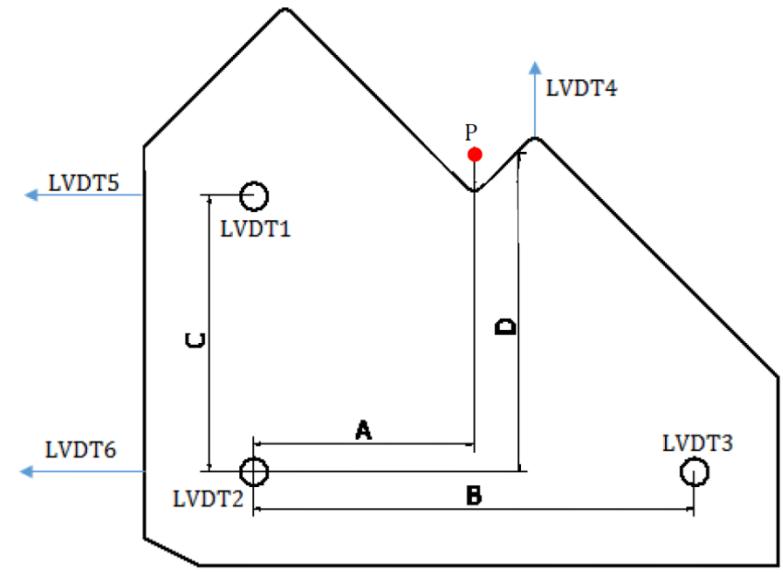




Measuring displacement

- Point **P** is the location of the proton-proton interaction point relative to the silicon, when the module is perfectly aligned i.e. $(x,y)=(0,0)$
- The measured values of the LVDTs are converted to a displacement of point **P**, by means of a transformation matrix

Displacement in X	LVDT 4
Displacement in Y	LVDT 5 & 6
Displacement in Z	LVDT 1, 2 & 3
Rotation X-axis	LVDT 2 & 3
Rotation Y-axis	LVDT 1 & 2
Rotation Z-axis	LVDT 5 & 6



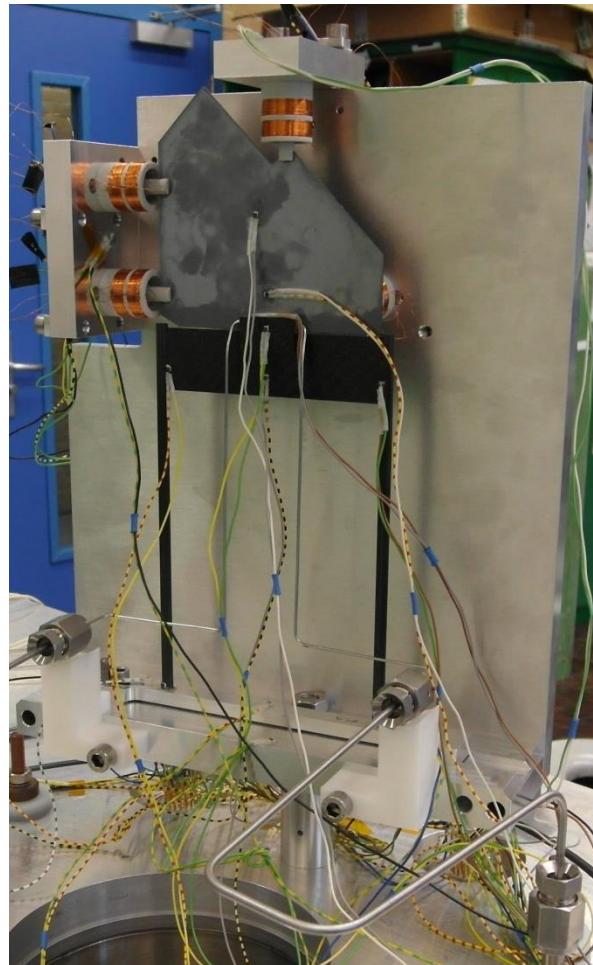
Nikhef modules

- Module I:
 - Cooling block **glued** to silicon
- Module II:
 - Cooling block **soldered** to silicon
 - Capillaries direct on CO₂ in/outlet
- Module III:
 - Mustache shaped cooling block
 - Metalized layer came loose, thus cooling block **glued** to silicon
 - 1/8 inch VCR connector



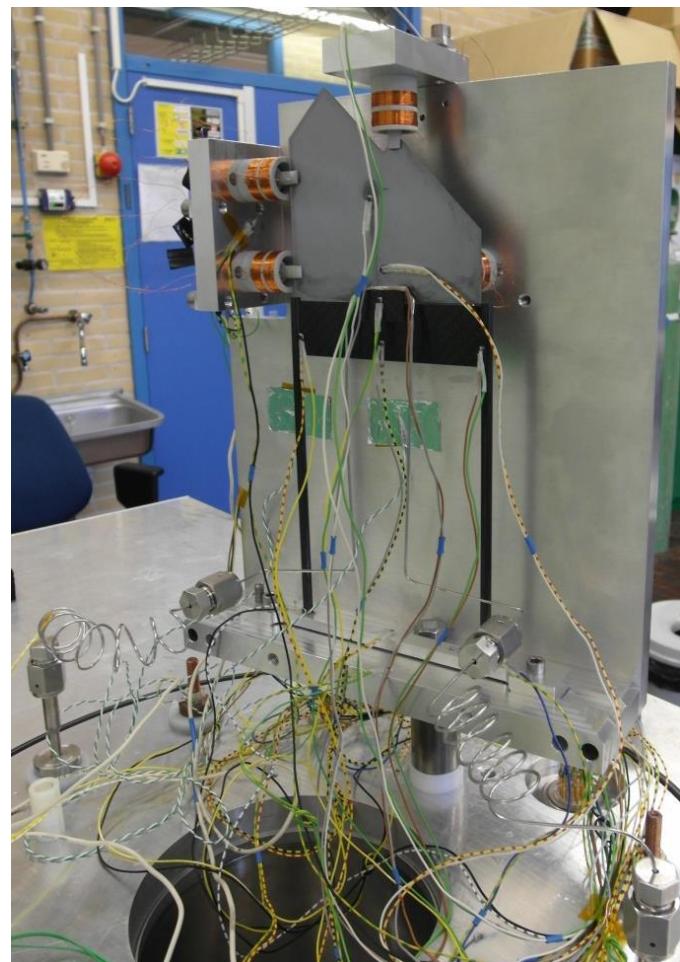
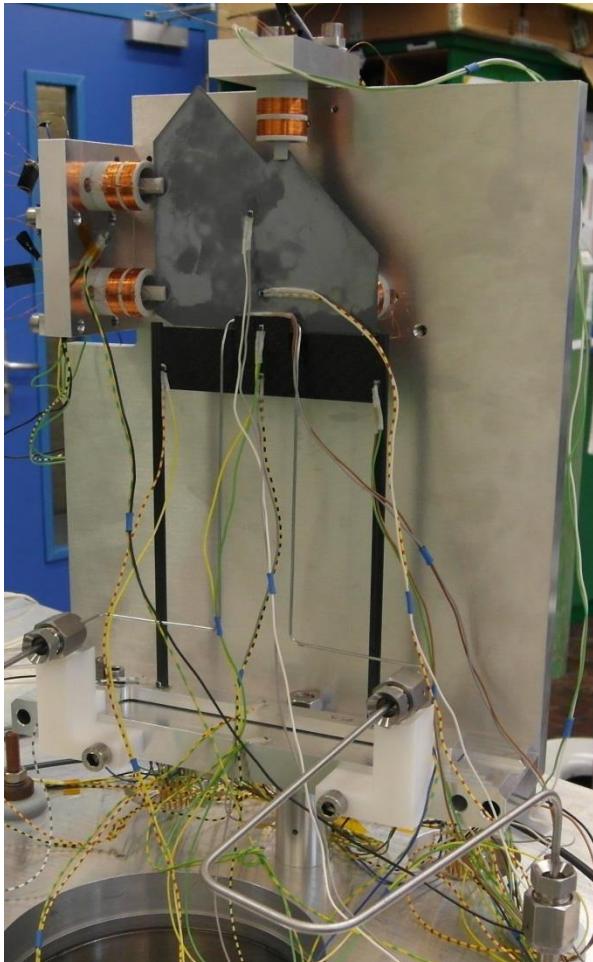
Nikhef module I

- Cooling block glued to the silicon
- Measurement 1 is with straight tubes connected to the capillaries of the module
- Measurement 2 is with pig-tail shaped tubes connected to the capillaries of the module



Nikhef module I

Straight tubes and pig-tail shaped tubes



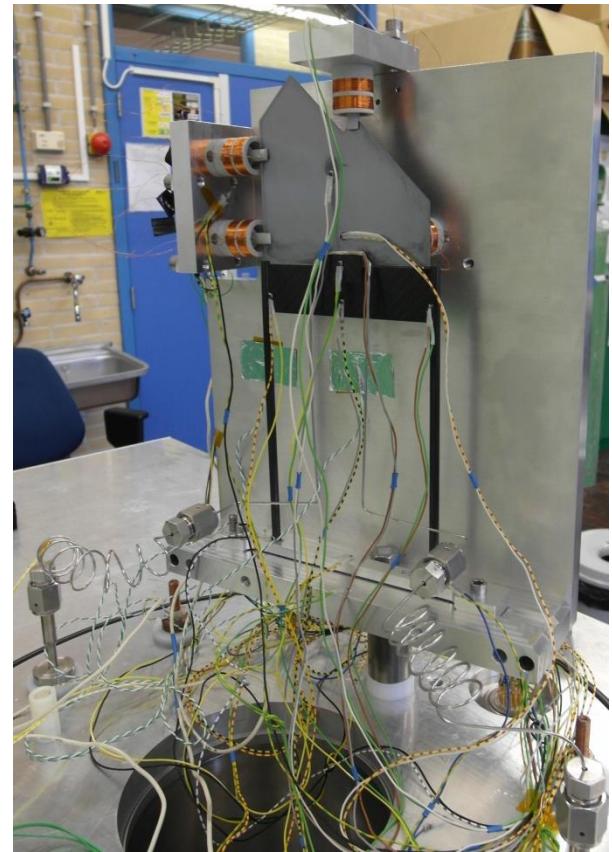
Displacement results

Nikhef module I

Sensor	Displacement (μm) Measurement 1	Displacement (μm) Measurement 2
LVDT 1	-17	-16
LVDT 2	-10	-11
LVDT 3	-2	-6
LVDT 4	-26	-27
LVDT 5	-8	-8
LVDT 6	-12	-12

Displacement of point P:

Displacement in X	-27 μm	Rotation X-axis	0.08 mrad
Displacement in Y	-7 μm	Rotation Y-axis	-0.12 mrad
Displacement in Z	-15 μm	Rotation Z-axis	0.08 mrad



Conclusion: changing the cooling pipe lay out does not affect the measurements

Extrapolation to -35 °C

Nikhef module I

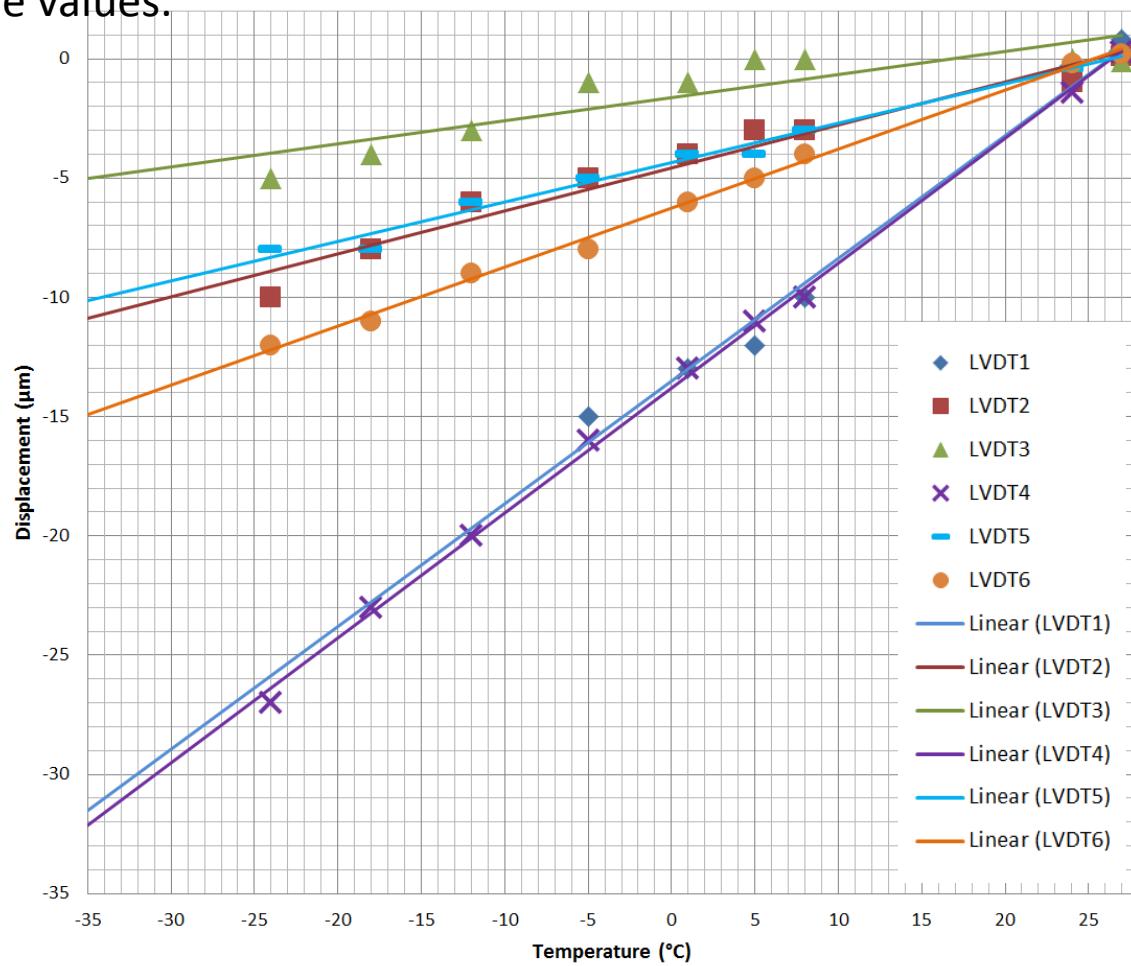
The cooling temperature is expected to be near -30 °C. A temperature of -35 °C is used for the extrapolation to find the extreme values.

Sensor	Displacement (μm)
LVDT 1	-33
LVDT 2	-11
LVDT 3	-5
LVDT 4	-33
LVDT 5	-10
LVDT 6	-15

Displacement of point P:

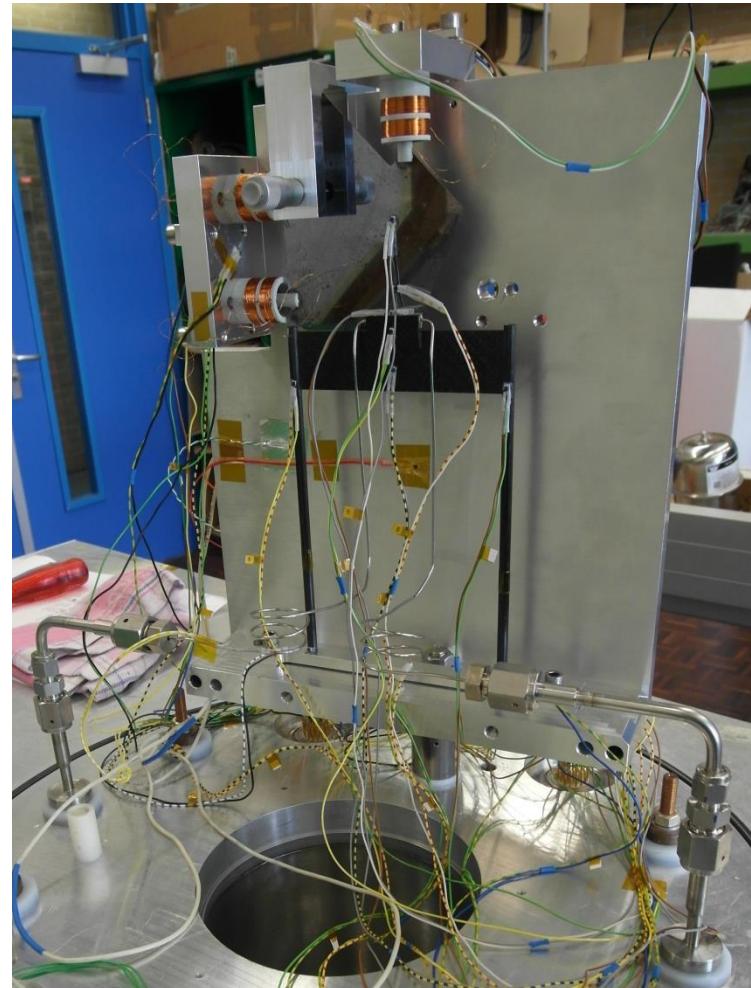
Displacement in X	-33 μm
Displacement in Y	-9 μm
Displacement in Z	-36 μm

Rotation X-axis	0.08 mrad
Rotation Y-axis	-0.44 mrad
Rotation Z-axis	0.10 mrad



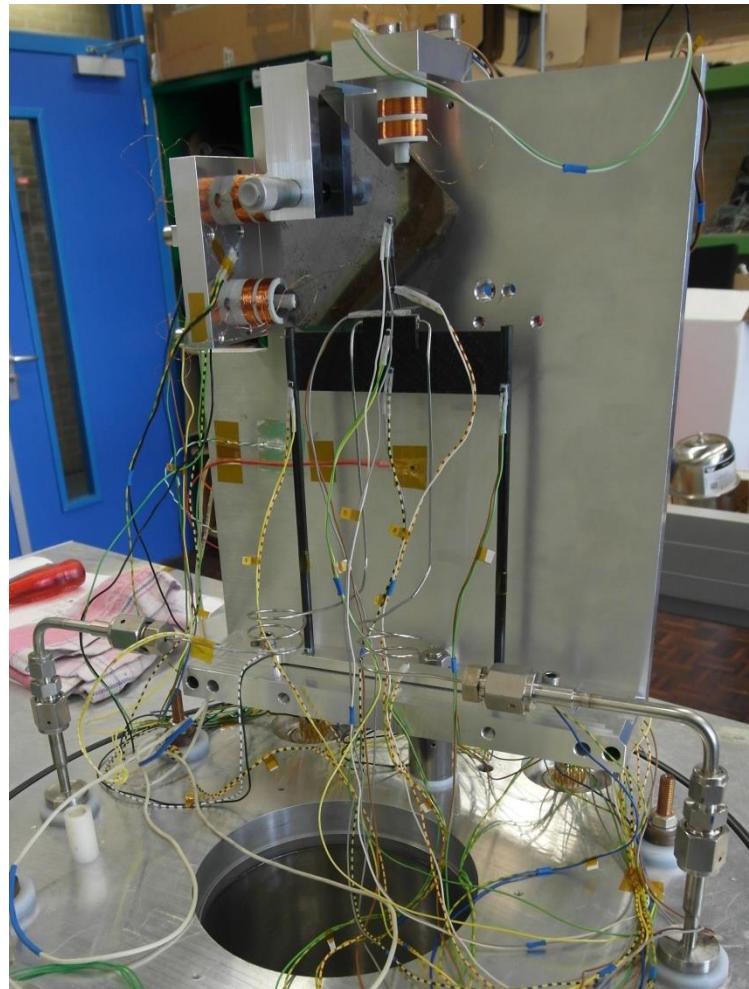
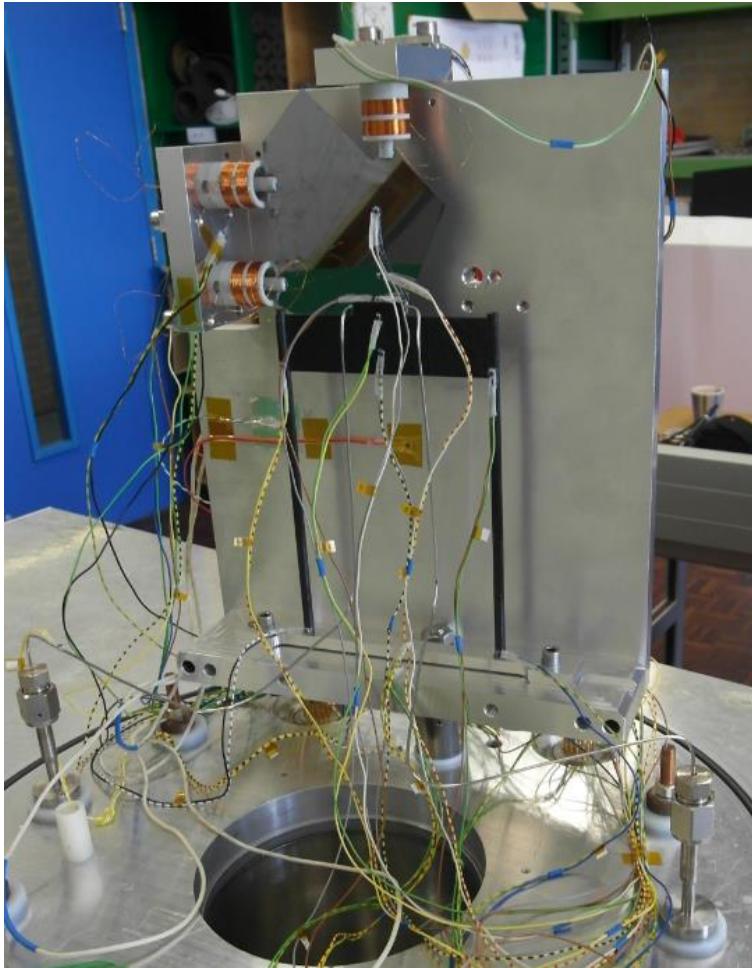
Nikhef module II

- Cooling block soldered on the silicon
- Silicon lost a ‘small’ corner due to handling the capillaries after bonding the silicon to the carbon hurdle →
- LVDT 3 can not be used for the measurement
- Measurement 1: capillaries connected to CO₂ in/outlet
- Measurement 4: pig-tail shaped capillaries



Nikhef module II

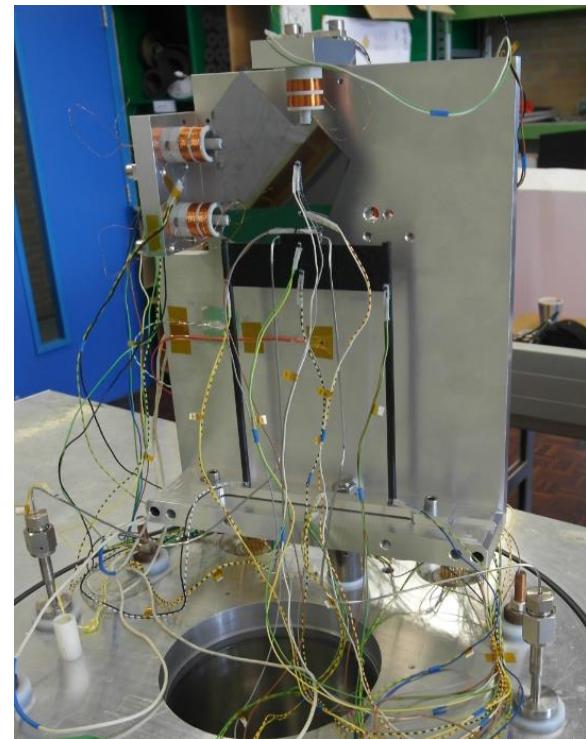
Straight tubes and pig-tail shaped tubes



Displacement results

Nikhef module II

Sensor	Displacement (μm)	
	Measurement 1 22-04-2015 -23.5 °C	Measurement 4 01-05-2015 -22.3 °C
LVDT 1	-162	-169
LVDT 2	-38	-38
LVDT 3	N/A	N/A
LVDT 4	-25	-26
LVDT 5	-10	-10
LVDT 6	-14	-14



Displacement of point P:

Displacement in X	-25 μm
Displacement in Y	~ -12 μm
Displacement in Z	~ -170 μm

Can not calculate the rotation, due to the missing LVDT 3

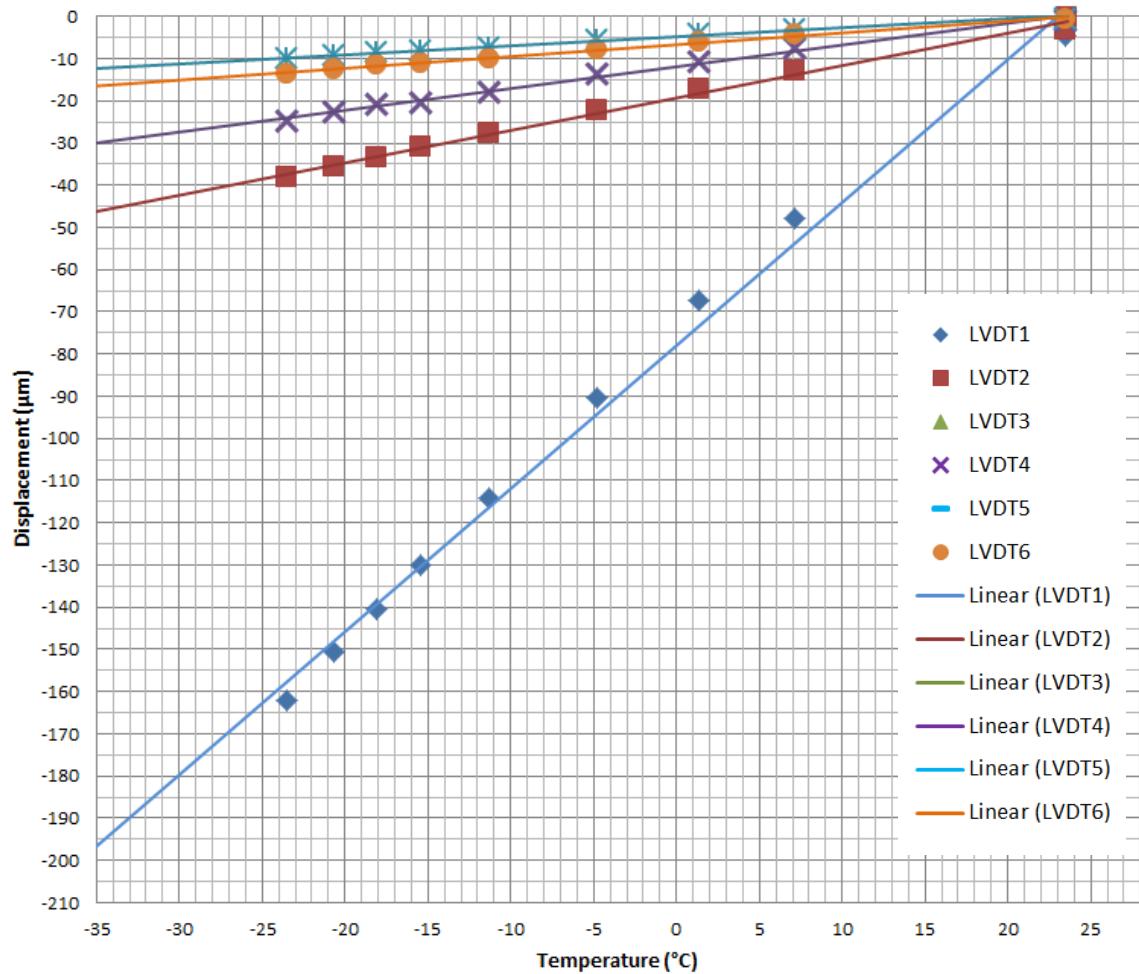
Extrapolation to -35 °C

Nikhef module II

Sensor	Displacement (μm) Measurement 1
LVDT 1	-197
LVDT 2	-56
LVDT 3	N/A
LVDT 4	-30
LVDT 5	-12
LVDT 6	-16

Displacement of point P :

Displacement in X	-30 μm
Displacement in Y	\sim -14 μm
Displacement in Z	\sim -200 μm

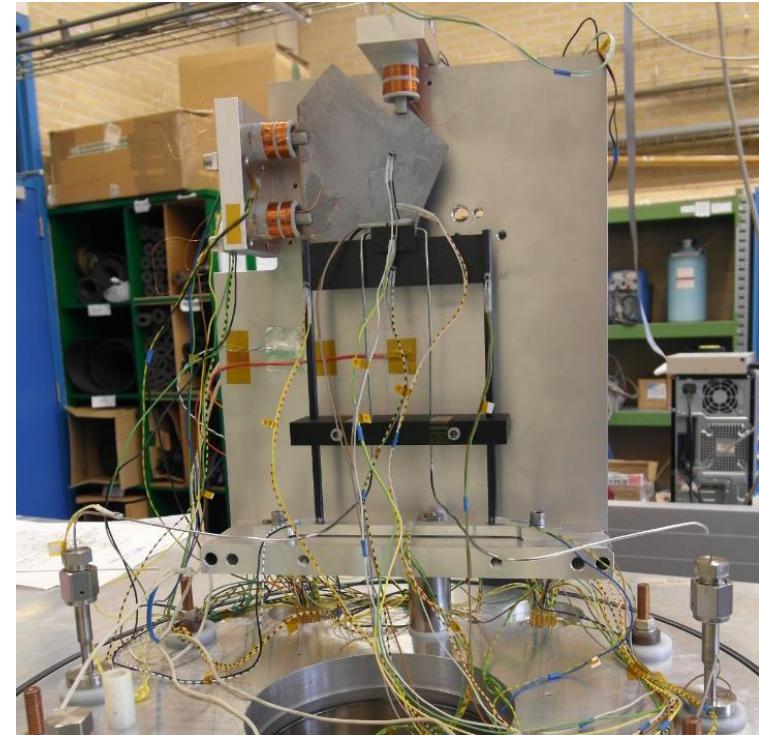


Extra measurements with constraint

Nikhef module II

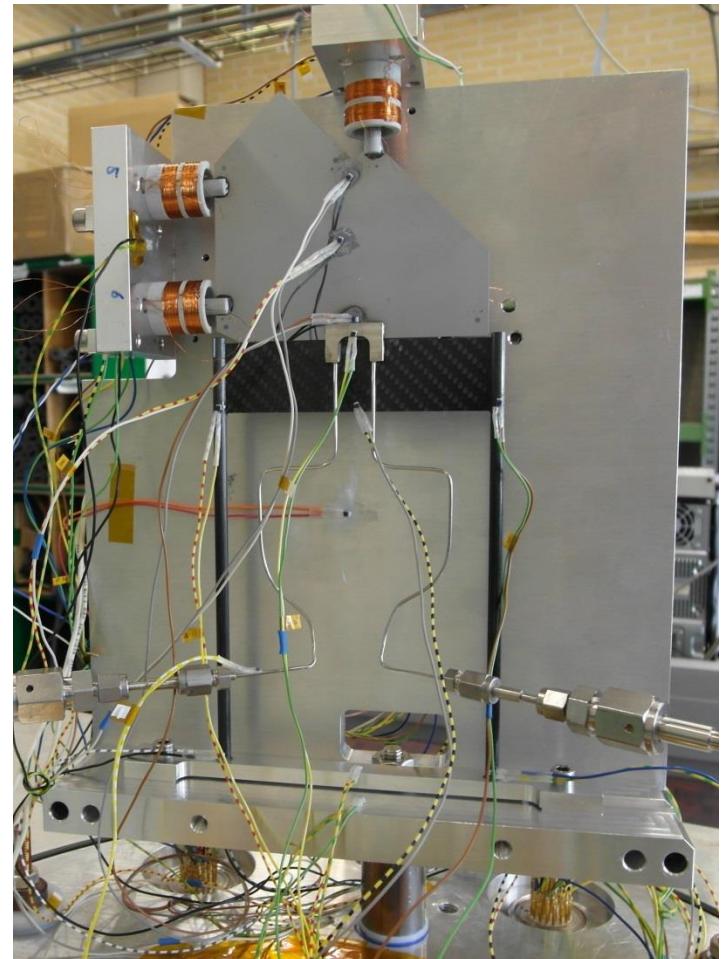
- Measurement 2: constrain capillaries, all directions
- Measurement 3: constrain in x & y direction
- The displacement for the module with an extra constraint is larger than without any constraint

Sensor	Displacement (μm) Measurement 2 24-04-2015 -24.1 °C	Displacement (μm) Measurement 3 29-04-2015 -23.2 °C
LVDT 1	-193	-243
LVDT 2	-47	-64
LVDT 3	N/A	N/A
LVDT 4	-27	-34
LVDT 5	-7	-6
LVDT 6	-10	-8



Nikhef module III

- Mustache shaped cooling block
- Cooling block glued to the silicon
- 1/8 inch VCR connector on the capillaries



Displacement results

Nikhef module III

Sensor	Displacement (μm) Measurement 1 21-05-2015 -26.8 °C
LVDT 1	-87
LVDT 2	-52
LVDT 3	-44
LVDT 4	-29
LVDT 5	-11
LVDT 6	-12

Displacement of point P for measurement 1:

Displacement in X	-29 μm
Displacement in Y	-11 μm
Displacement in Z	-93 μm
Rotation X-axis	0.10 mrad
Rotation Y-axis	-0.70 mrad
Rotation Z-axis	0.03 mrad

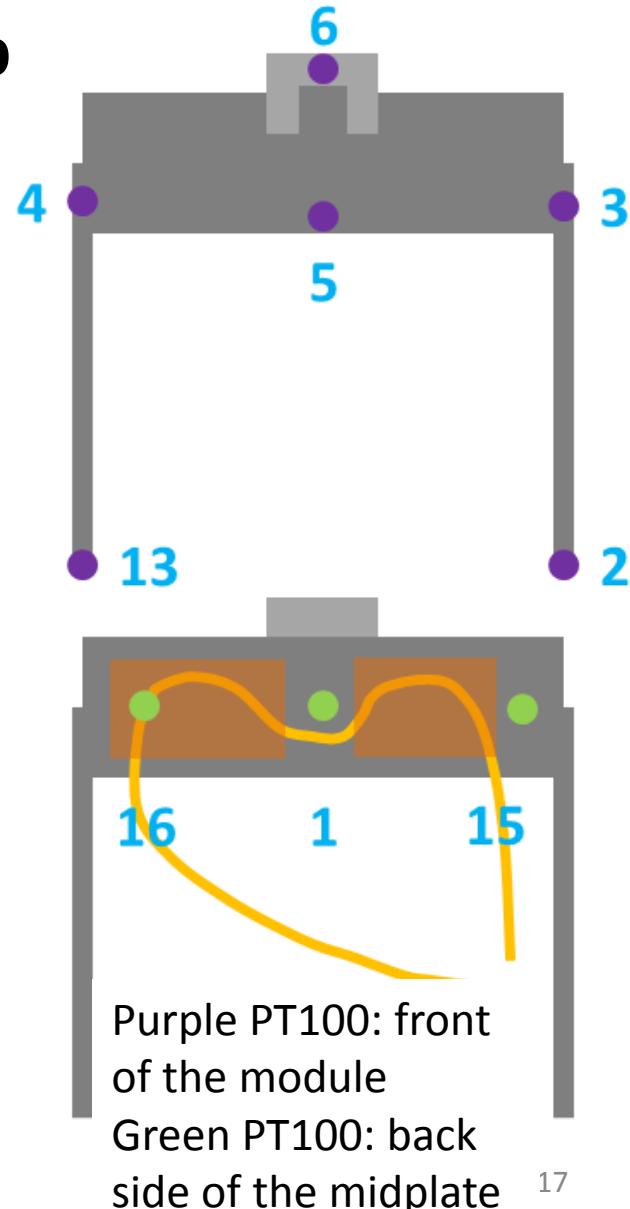
Displacement of point P for extrapolation to -35 °C :

Displacement in X	-32 μm
Displacement in Y	-11 μm
Displacement in Z	-105 μm
Rotation X-axis	0.11 mrad
Rotation Y-axis	-0.72 mrad
Rotation Z-axis	0.04 mrad

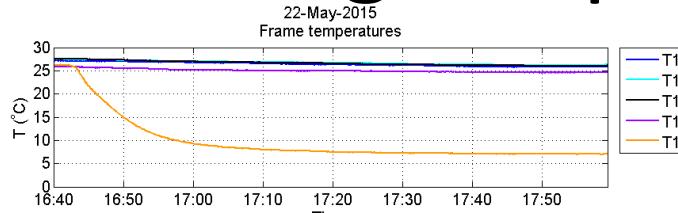
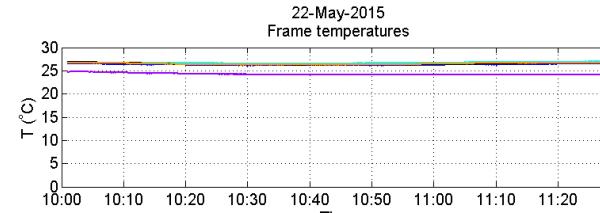
Additional cooling midplate

Nikhef module IIIb

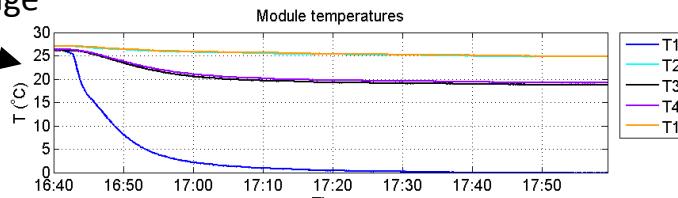
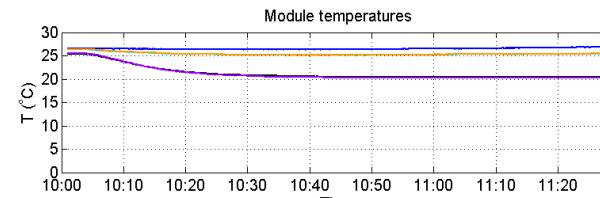
- From the LVDT1/LVDT2 ratio can be derived that the rotation point is situated at the height of the midplate
- Additional cooling on the back of the midplate for a more homogeneous temperature → less deformation
- Sensors T1, T15 & T16 are relocated to the back of the midplate for the second measurement



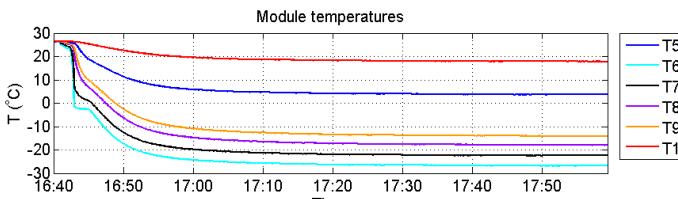
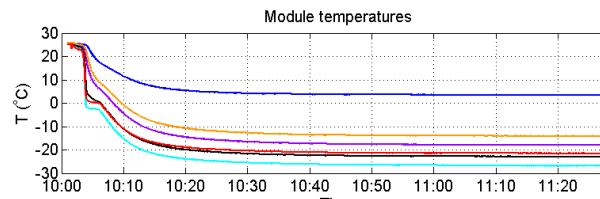
Results additional cooling midplate



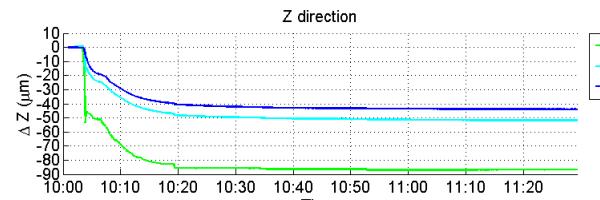
**T1, T15 and
T16 are
relocated to
the midplate!**



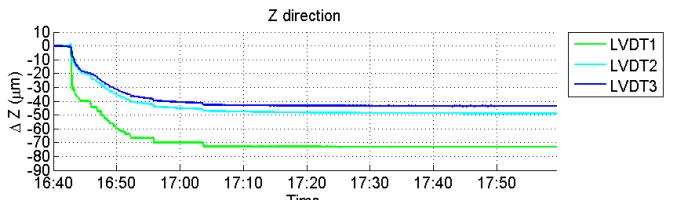
Temperatures
hurdle don't change



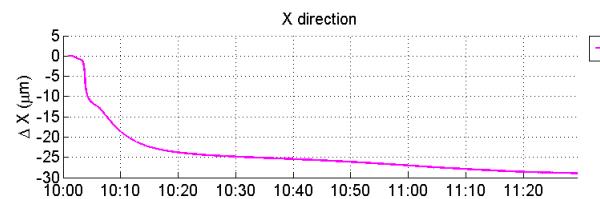
**Makes a
difference for
LVDT 1,
though not yet
enough...**



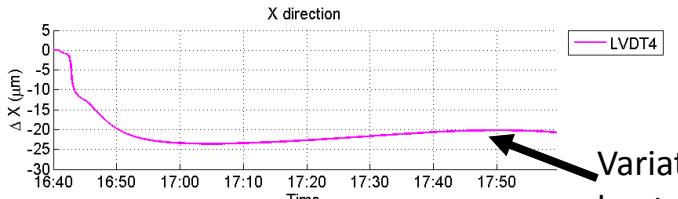
LVDT 1: -87
LVDT 2: -52
LVDT 3: -44



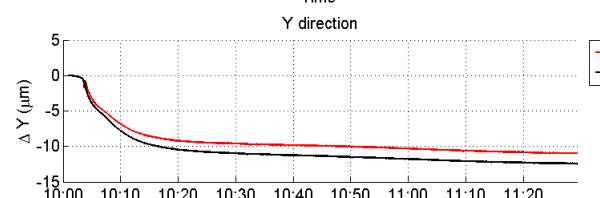
LVDT 1: -72
LVDT 2: -49
LVDT 3: -44



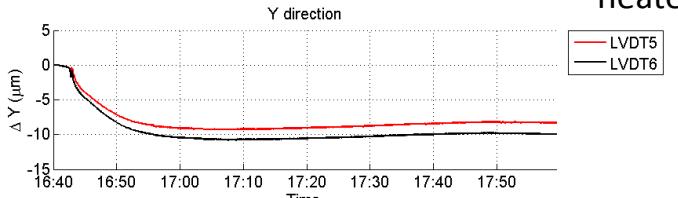
LVDT 4: -29



LVDT 4: -23



LVDT 5: -11
LVDT 6: -12

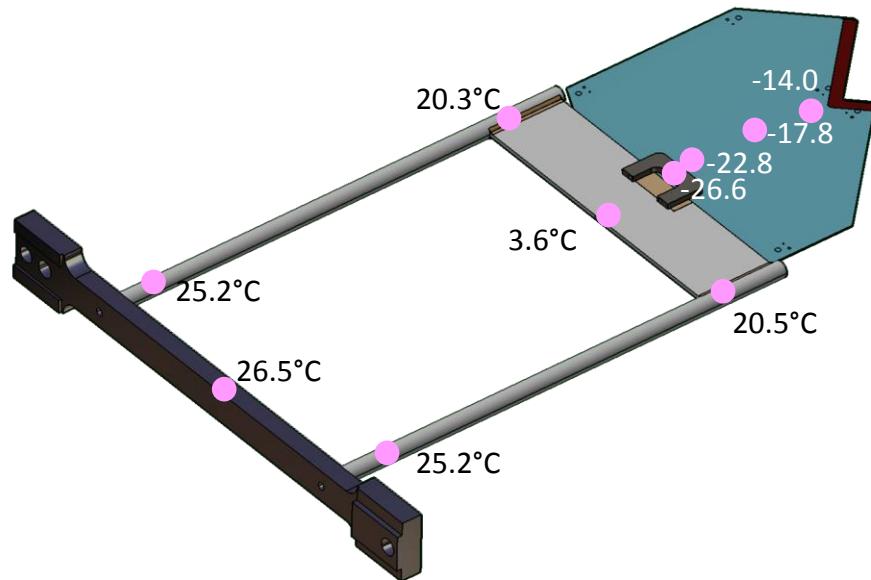


LVDT 5: -9
LVDT 6: -11

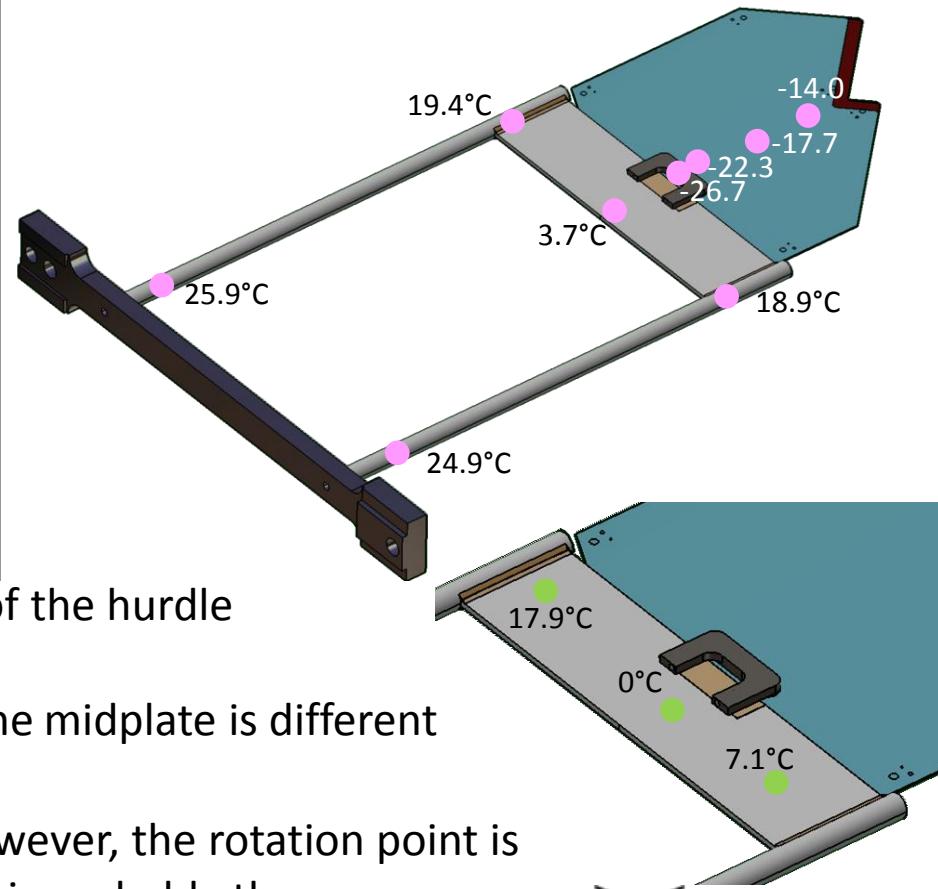
Variations due to
heater control

Comparison temperature IIIa and IIIb

Module IIIa



Module IIIb



There is a temperature gradient over the rods of the hurdle

$$\Delta T_{IIIa} \approx 5^\circ\text{C} \text{ & } \Delta T_{IIIb} \approx 6^\circ\text{C}$$

The temperature of the front and the back of the midplate is different

$$T_{front} = 3.7^\circ\text{C} \text{ & } T_{back} = 0^\circ\text{C}$$

Both can cause deformation of the module. However, the rotation point is located near the midplate → thus the midplate is probably the cause

Displacement results

Nikhef module IIIb

Sensor	Displacement (μm) Measurement 2 22-05-2015 -26.9 °C
LVDT 1	-72
LVDT 2	-49
LVDT 3	-44
LVDT 4	-23
LVDT 5	-9
LVDT 6	-11

Displacement of point P for measurement 1:

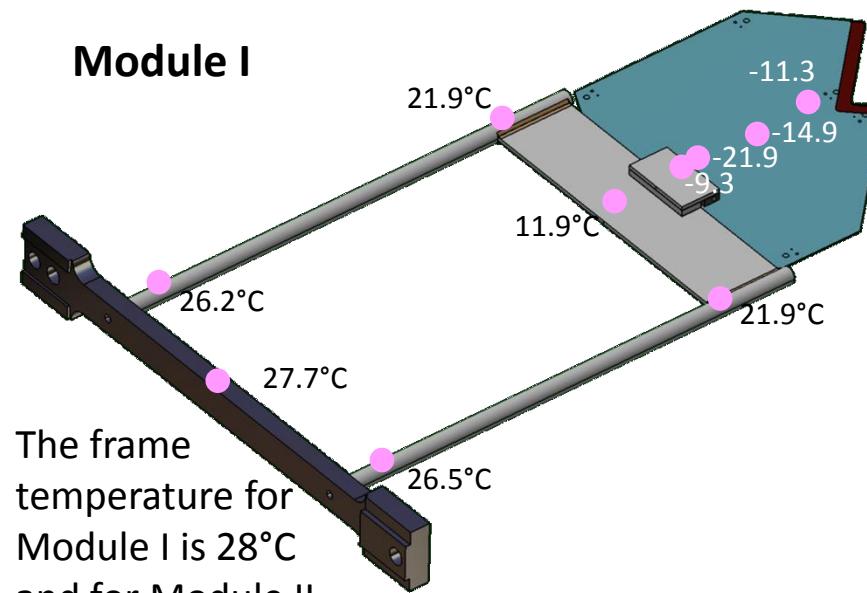
Displacement in X	-23 μm
Displacement in Y	-8 μm
Displacement in Z	-76 μm
Rotation X-axis	0.06 mrad
Rotation Y-axis	-0.46 mrad
Rotation Z-axis	0.04 mrad

Displacement of point P for extrapolation to -35 °C :

Displacement in X	-27 μm
Displacement in Y	-11 μm
Displacement in Z	-90 μm
Rotation X-axis	0.08 mrad
Rotation Y-axis	-0.58 mrad
Rotation Z-axis	0.02 mrad

Comparison with thermal model

Module I

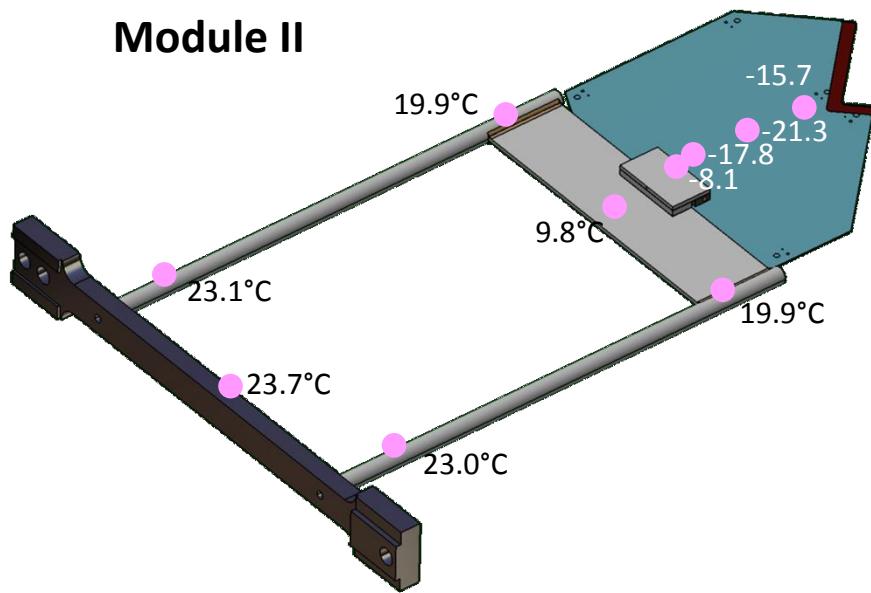


The frame temperature for Module I is 28°C and for Module II 23.9°C

The capillary temperature at the CO₂ inlet side for Module I is -22.9°C and for Module II -23.4°C

Only a complete and detailed model can provide a good prediction

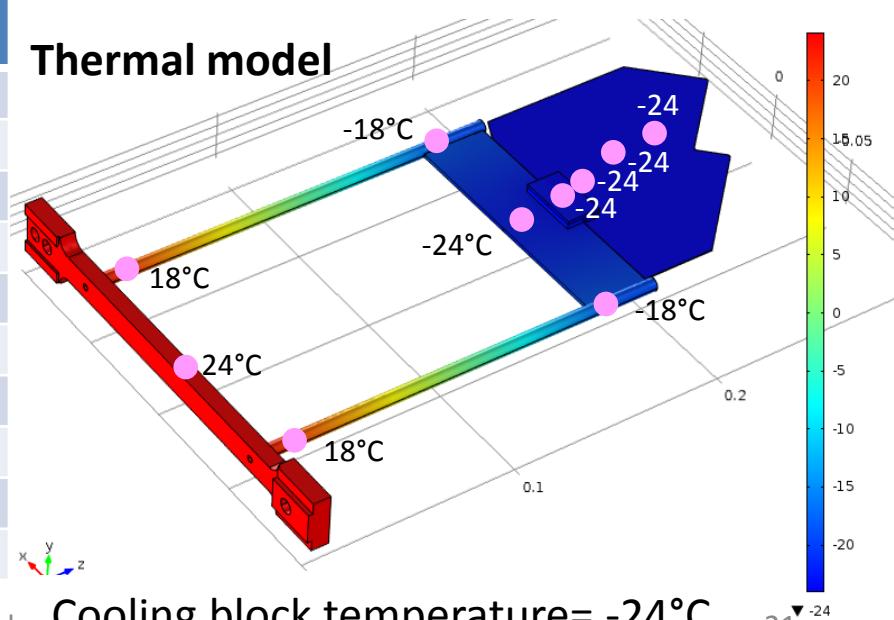
Module II



Module I 17-02-2015 14:00		Module II 22-04-2015 12:00		Thermal model	
T1	27.7	T1	23.7	T1	24
T2	26.5	T2	23.0	T2	18
T3	21.9	T3	19.9	T3	-18
T4	21.9	T4	19.9	T4	-18
T5	11.9	T5	9.8	T5	-24
T6	-9.3	T6	-8.1	T6	-24
T7	-21.9	T7	-17.8	T7	-24
T8	-14.9	T8	-21.3	T8	-24
T9	-11.3	T9	-15.7	T9	-24
T13	26.2	T13	23.1	T13	18
T15	-22.9	T15	-23.4		
T16	28.0	T16	23.9		

LO Upgrade module

Thermal model

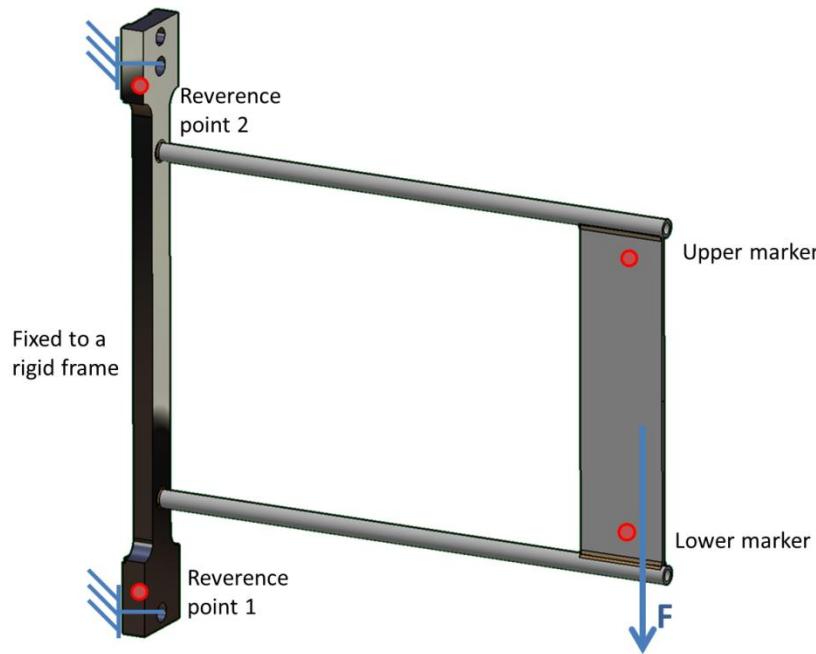


Cooling block temperature = -24°C

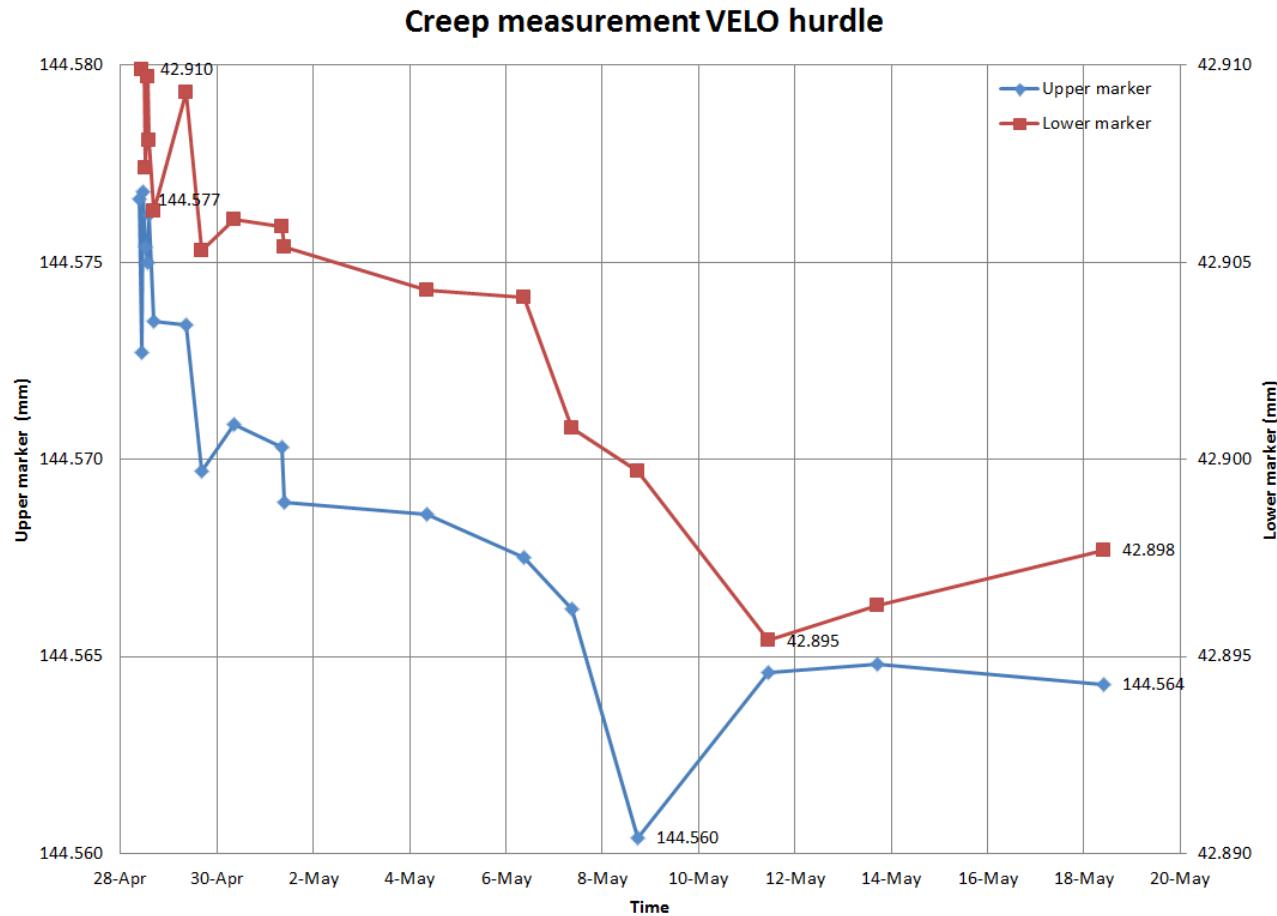
Thermal model by John Back, University of Warwick

Creep test VELO hurdle

- 3 weeks with a constant load of 420 grams
- Accuracy $\pm 4 \mu\text{m}$



Creep test VELO hurdle results



The lower marker moved down 12 μm

The upper marker moved down 15 μm

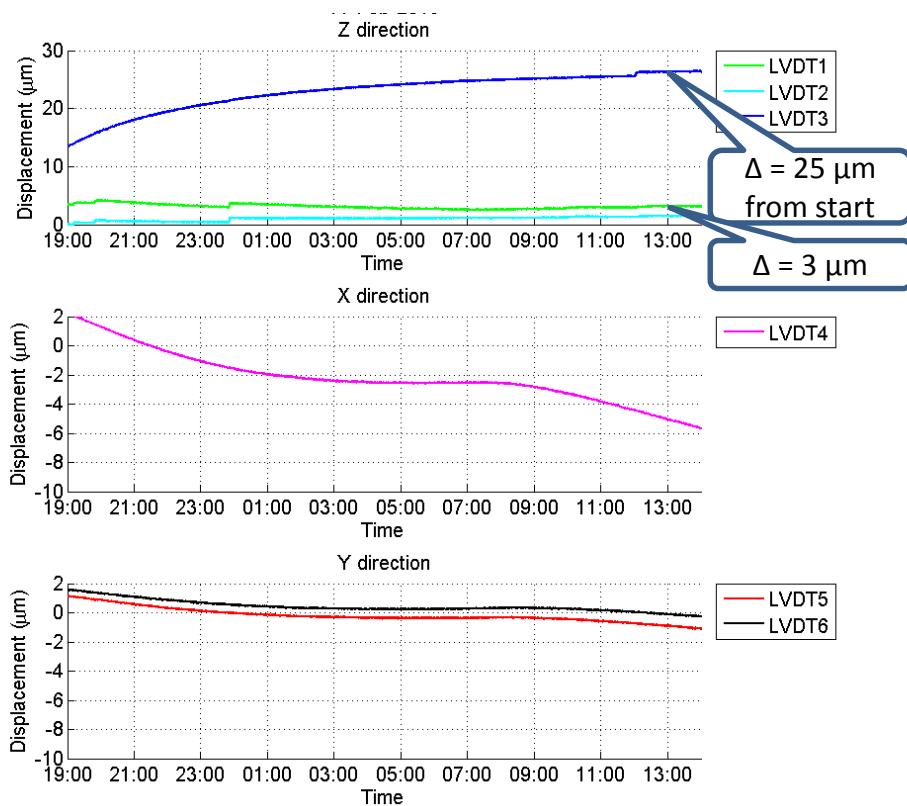
Creep is a significant effect thus creep test is ongoing

Conclusion

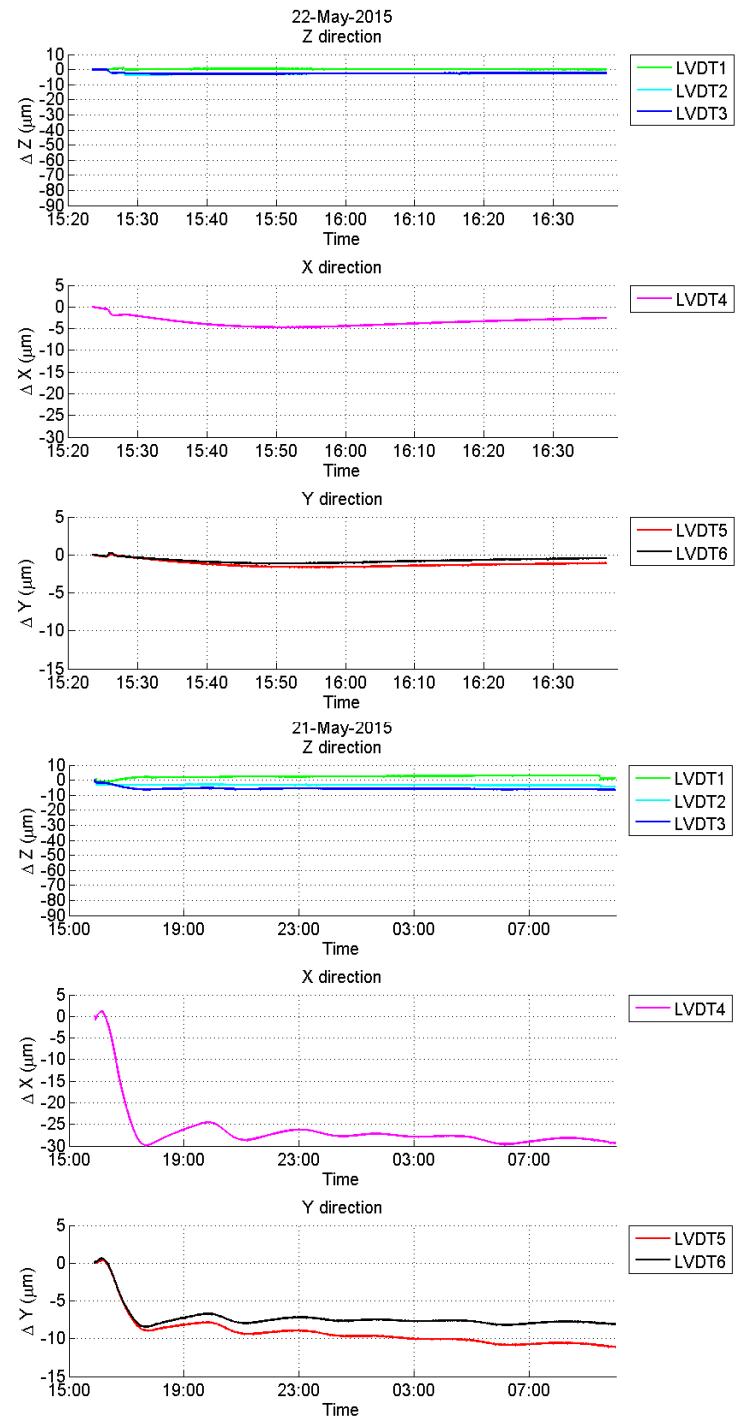
- The displacements at the "point P" as the result of a ΔT of 55°C (cooling temperature of -35°C) are
 - About -30 μm in X → predictable
 - About -10 μm in Y → small
 - About -36, -200 and -93 μm for module I, II and III, respectively in Z → requires further study
- Constraining the capillaries causes a larger displacement of the silicon and thus "point P"
- Additional cooling on backside of mid plane reduces displacement in Z
 - Rotation of the silicon may be caused by inhomogeneous temperature of midplate
 - Deformation of the midplate may be due to cooling, a possible solution is optimizing the midplate by:
 - differently 'woven' carbon fiber?
 - temperature 'vias'?
 - Deformation of the hurdle may be due to radiation from the frame, a possible solution is optimizing the test setup by adding a heat shield
- It is difficult to predict the behavior of the module by means of a thermal model due to the many variables and uncertainties.
- There is an observable result in the creep test, when naively extrapolated there is a large effect (order 100 micron) → requires further study

Evacuate system

- For module I the displacement due to pump down is $25\mu\text{m}$
- For module III, there is no significant movement due to pump down

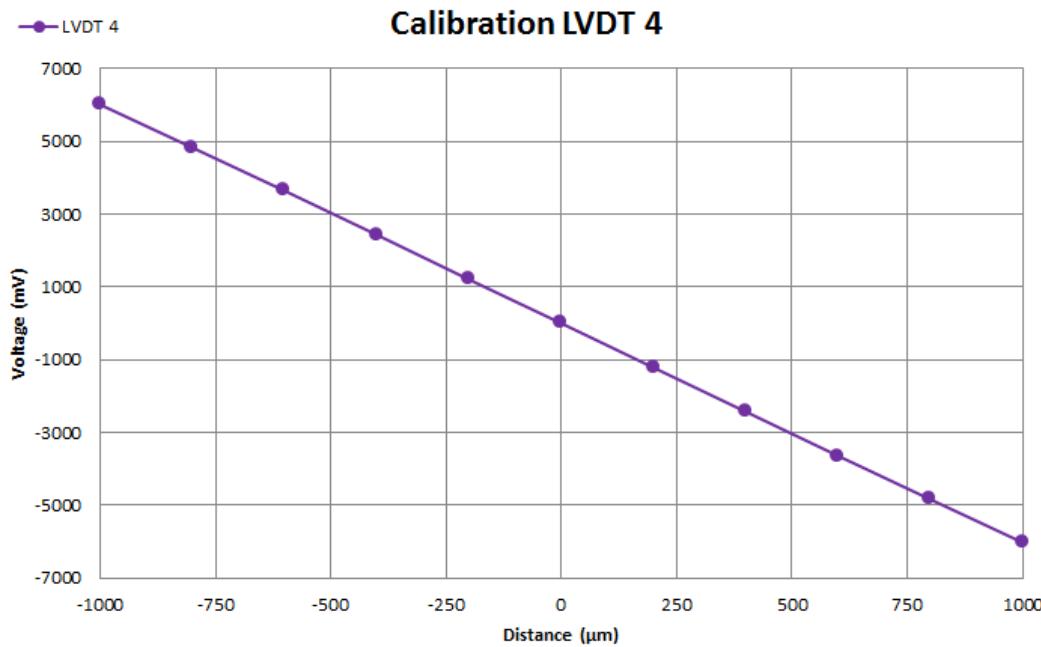


e WOI



Calibration LVDT sensor

- Calibration of LVDT sensors in a range of -1000 to +1000 μm
- Small influence of eddy currents on LVDT signal
- Standard deviation for calibration better than $10^{-4} \mu\text{m}$
- Radial tra



Thermal model with convection

